



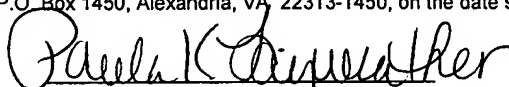
Docket No.: A0312.70491US00

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Alan W. Righter
Serial No.: 10/694675
Confirmation No.: 4241
Filed: October 28, 2003
For: INTEGRATED CIRCUIT BOND PAD STRUCTURES
AND METHODS OF MAKING
Examiner: C. Q. Nguyen
Art Unit: 2811

I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as First Class Mail, in an envelope addressed to: **MS Amendment**, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on the date shown below.

Dated: November 10, 2005


Paula K. Fairweather

AMENDMENT

MS Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the Office Action mailed July 14, 2005, please amend the above-identified application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 8 of this paper.